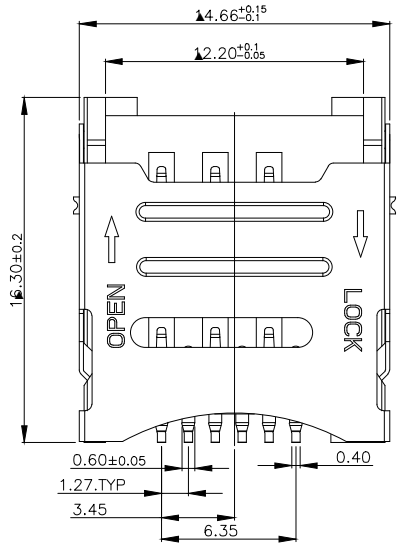
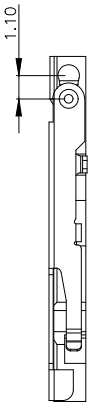
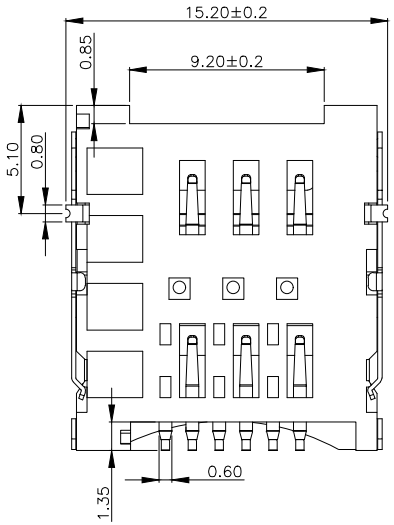
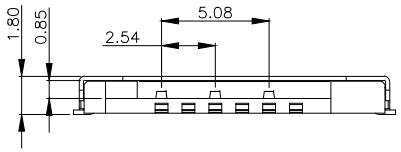
ROHS Compliant

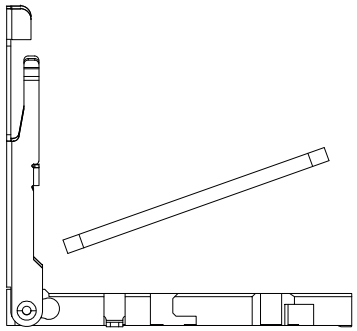
| MAPX | MODIFICATION | DATE | DRAW | APPROVE |
|---|---|---|---|---|
| | | | | |



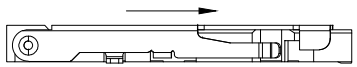



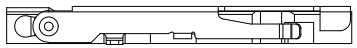



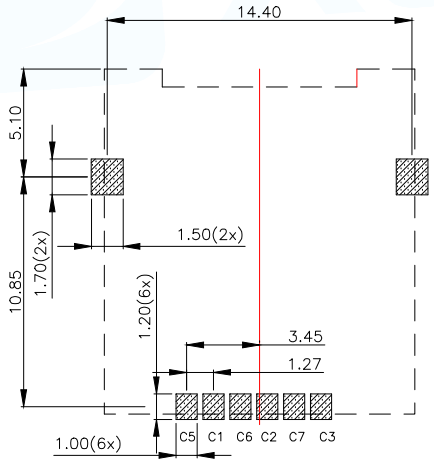
STEP 1 INSERT MICRO SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH




PAD AREA

KEEP OUT AREA

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

| MICRO SIM CARD | |
|---|---|
| Pin No. | NAME |
| C1 | VCC OF SIM |
| C2 | RST OF SIM |
| C3 | CLK OF SIM |
| C5 | GND OF SIM |
| C6 | VPP OF SIM |
| C7 | I/O OF SIM |
| C4/C8 | N/A |

一、材质和镀涂:

1、胶芯: LCP,UL 94V-0,黑色

2、端子: 磷铜C5210-H,T=0.15,
全区镍底30u"MIN
触点镀金GOLD FLASH0.6-1.0u"
焊脚双面镀亮锡50-80u'

3.定位脚:磷铜C2680-H,T=0.20,
全区镍底30u"MIN,镀亮锡50-80u"

4、外壳: 不锈钢 T=0.2

二、技术参数:

接触电阻: 100MΩ MAX

绝缘阻抗: 1000MΩ MIN(500DC)

额定电流: 每个接触件1A MAX

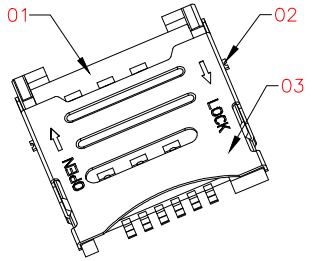
额定电压: 30V MAX(DC)

耐 压: 500V R.M.S/MIN

使用温度: -40℃~85℃

湿 度: 80% R.H MAX

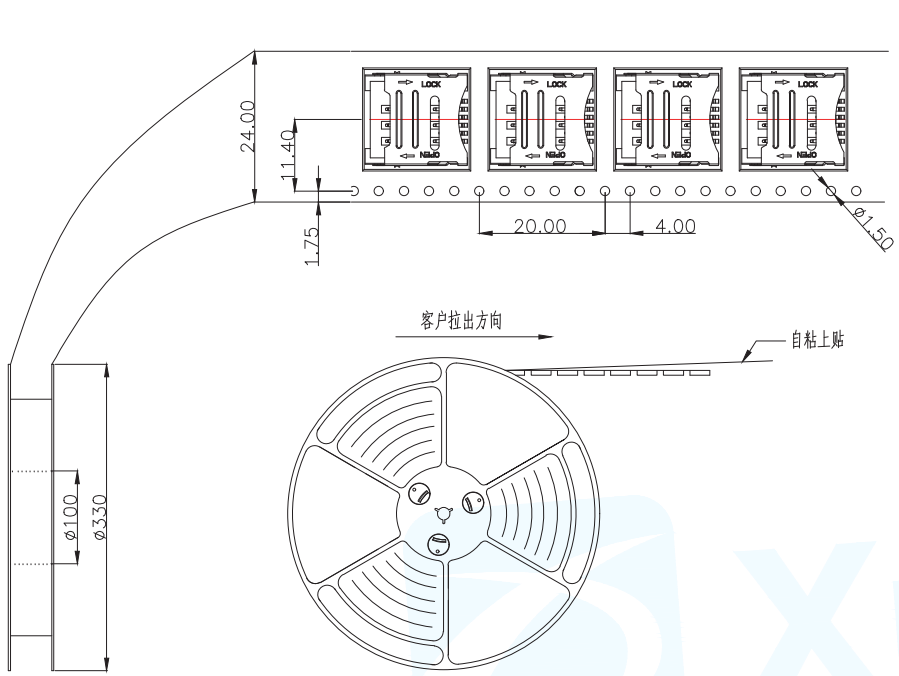
寿 命: >3000次




| MANUFACTURE DWG | 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co,Ltd | |
|---|---|---|
| UNLESS OTHERWISE SPECIFED TOLERANCES | | TITLE:MICRO SIM CARD HINGED 6PIN H1.8 掀盖式 |
| DECIMALS: / ANGLES: | | PAR: SMC-216-ARP6 |
| X.:±0.50 / X.°:±2° | | DWN: |
| X.X:±0.30 / X.X°:±1° | | CHKD: |
| X.XX:±0.20 | CUSTOMER COPY | APVD: |
| | | SCALE1:1 / UNIT:MM |
| | | SIZE:A4 / SHEET:1F1 / REV:A |

ROHS Compliant

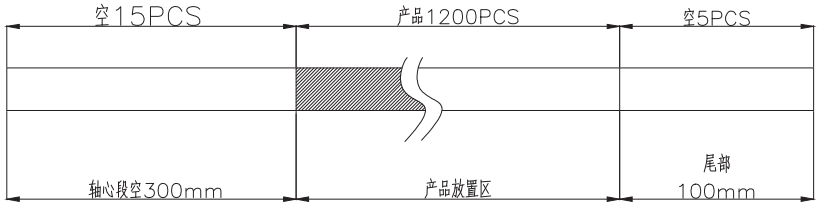
| MAPX | MODIFICATION | DATE | DRAW | APPROVE |
|---|---|---|---|---|
| | | | | |




NOTES

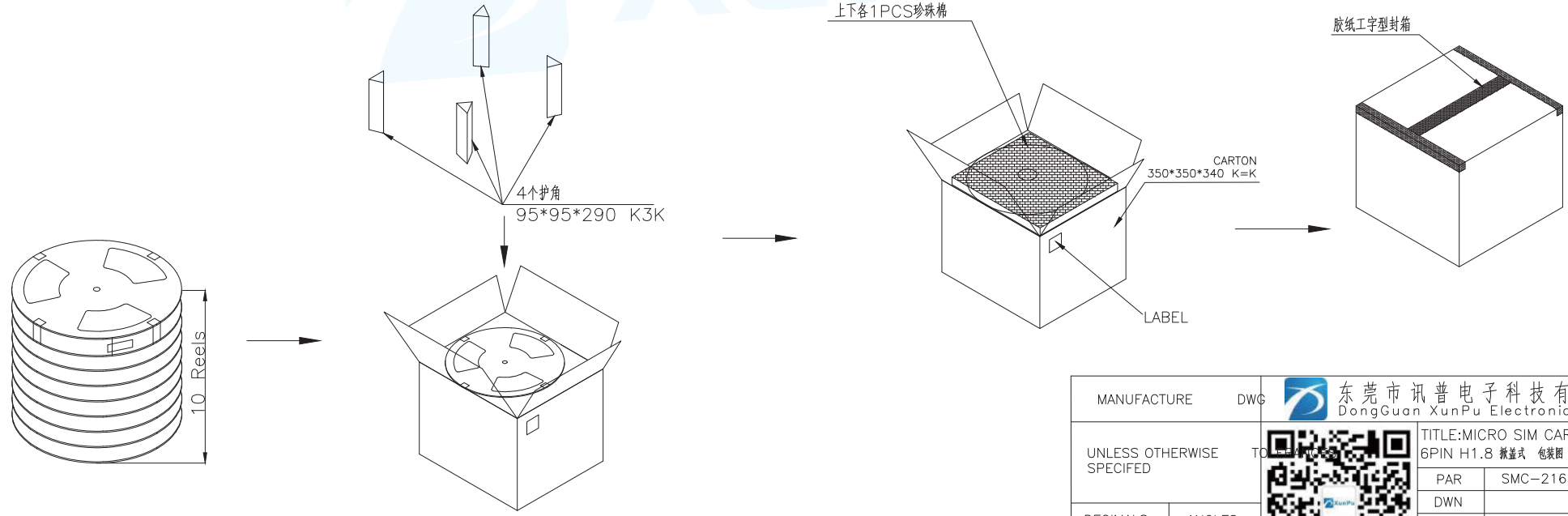
1.每卷包装数量:1200PCS/每卷

2.卷带包装方式:




3.每箱包装数量:12000PCS/箱

4.纸箱350mm*350mm*440mm(内部尺寸),材质K=K




| | | | |
|---|---|---|---|
| MANUFACTURE | DWG | 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co,Ltd | |
| UNLESS OTHERWISE SPECIFED | TOLERANCES | TITLE:MICRO SIM CARD HINGED 6PIN H1.8 掀盖式 包装图 | |
| | | PAR | SMC-216-ARP6 |
| DECIMALS: | ANGLES: | DWN | |
| X.:±0.50 | X.°:±2° | CHKD | |
| X.X:±0.30 | X.X°:±1° | APVD | |
| X.XX:±0.20 | | SCALE1:1 | UNIT:MM |
| CUSTOMER COPY | | SIZE:A4 | SHEET:1F1 REV:A |